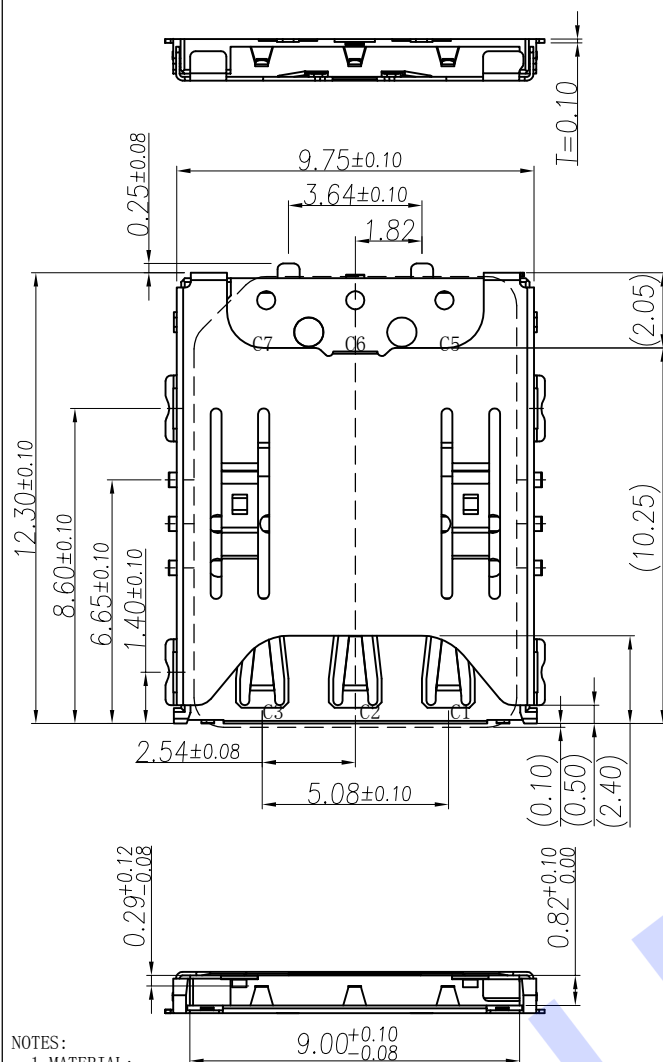


ROHS

REV.	ECN. #	DESCRIPTION	DATE
A0	_____	NEW RELEASE	10/29/21



NOTES:

1. MATERIAL:

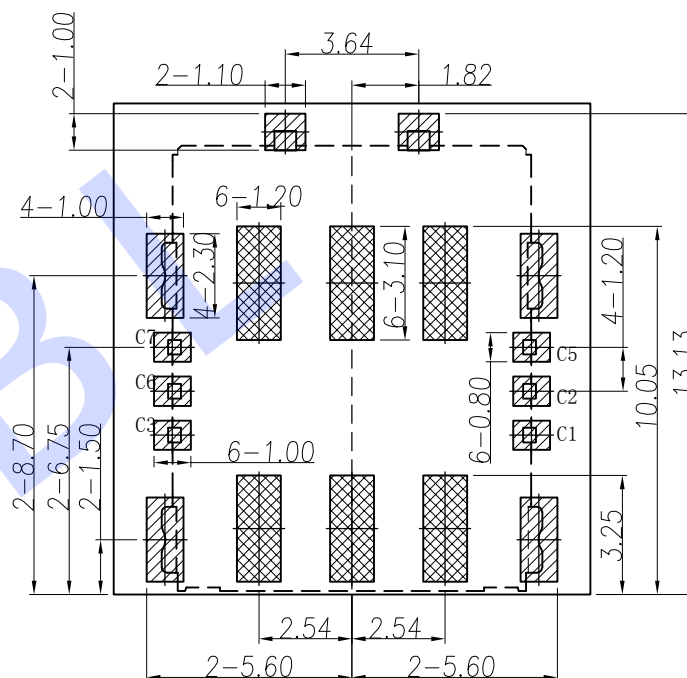
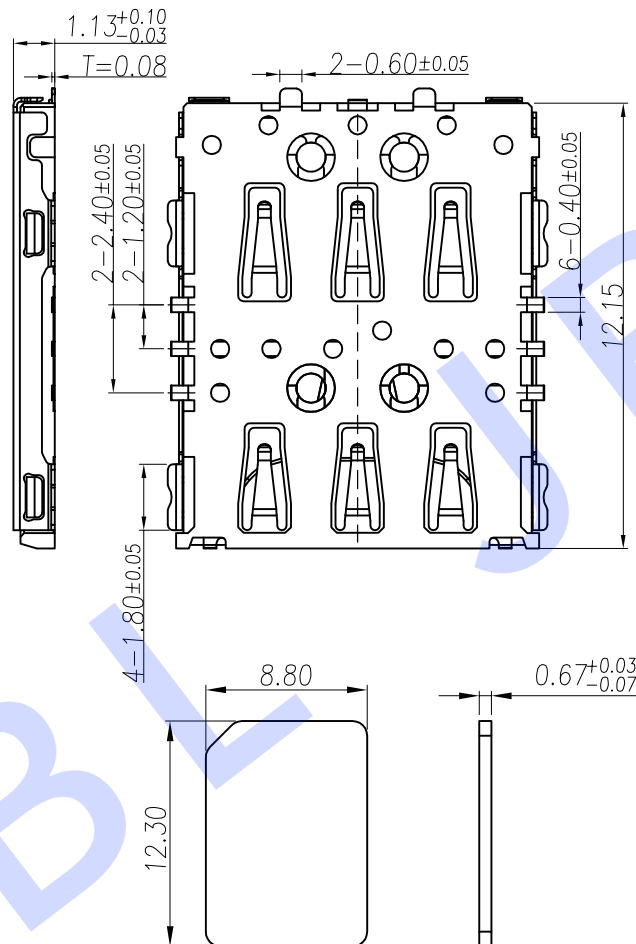
HOUSING:High Temperature Thermoplastic
Terminal:Copper Alloy
Shell:Stainless Steel

2. PLATING:

Terminal:30u" Ni UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA
100u" TIN PLATED ON SOLDER AREA
Shell:30u" Ni UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA AND SOLDER AREA

3. TECHNICAL SPECIALITY:

RATED VOLTAGE:30V AC MAX.
CURRENT RATING:0.5A MAX.
INSULATION RESISTANCE:1000MΩ MIN
CONTACT REISTANCE:100mΩMAX
WITHSTANDING VOLTAGE:500V AC FOR 1 MINUTES
OPERATING TEMPERATURE:-20℃~+85℃ Humidity80%R.HMAX



RECOMMENDED PCB LAYOUT

TOLERANCE: ± 0.05

-  SMT SOLDER AREA
 COPPER RESTRICTED AREA
 1. TOUCH AREA OF CONTACT
 TIPS NO ELECTRICAL FUNCTION
 2. NO FIRST PCB_LAYOUT
 CIRCUITS IN THE AREA

		MILLIMETERS		INCH		东莞市金比莱五金塑胶科技有限公司 DongGuan JinBiLai Metal Plastic TechnologyCo.,.Ltd							
		X. ° ±2°		X. ° ±2°									
PIIN/NO	ASSIGNMENT	X ±0.30		.X ±0.012		TITLE	1. 13H NO-PUSH NANO-SIM CARD			DR			
		.XX ±0.20		.XX ±0.008									
		.XXX ±0.10		.XXX ±0.004									
		C1 VCC											
		C2 RST											
		C3 CLK											
C5	GND	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF DongGuan JinBiLai Metal Plastic Technology Co., Ltd COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF DongGuan JinBiLai Metal Plastic Technology Co.,Ltd				PART NO.	102315212			CHKD			
C6	VPP												
C7	I/O												
						PRO J.	PAGE	1/2	UNITS	mm	APPD		
							SIZE	A4	SCALE	1:1	DIS NO.	NS008-000<客户图>	

